# **74ABT20**

# **Dual 4-input NAND gate**

Rev. 3 — 12 August 2016

Product data sheet

### 1. General description

The 74ABT20 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT20 is a dual 4-input NAND gate.

### 2. Features and benefits

- Latch-up protection exceeds 500 mA per JESD78B class II level A
- ESD protection:
  - ♦ HBM JESD22-A114F exceeds 2000 V
  - ♦ MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from –40 °C to +85 °C

## 3. Ordering information

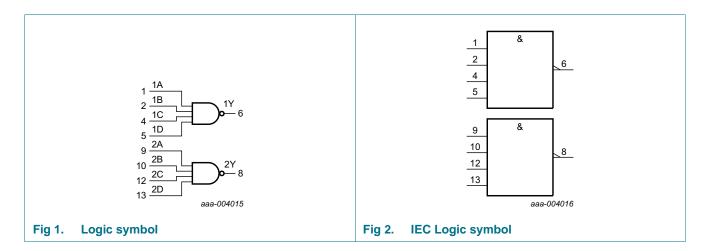
Table 1. Ordering information

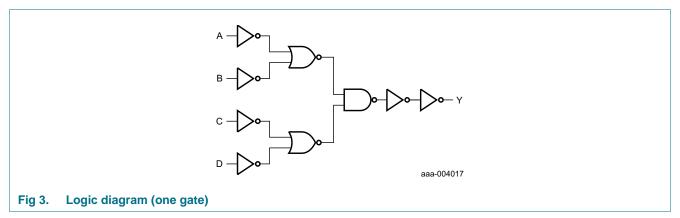
Type number	Package												
	Temperature range	Name	Description	Version									
74ABT20D	−40 °C to +85 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1									
74ABT20DB	–40 °C to +85 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1									
74ABT20PW	–40 °C to +85 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1									



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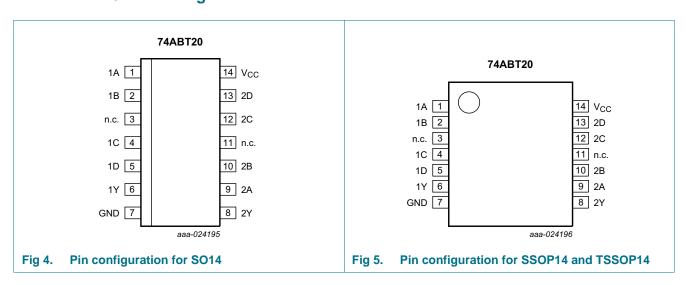
# 4. Functional diagram





# 5. Pinning information

### 5.1 Pinning



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## 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1A, 1B, 1C, 1D	1, 2, 4, 5	data input
n.c.	3, 11	not connected
1Y	6	data output
GND	7	ground (0 V)
2Y	8	data output
2A, 2B, 2C, 2D	9, 10, 12, 13	data input
V <sub>CC</sub>	14	supply voltage

# 6. Functional description

Table 3. Function table[1]

Input										
nA	nB	nC	nD	nY						
L	Х	Х	Х	Н						
X	L	Х	Х	Н						
X	Х	L	Х	Н						
X	Х	Х	L	Н						
Н	Н	Н	Н	L						

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; X = don't care.

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7.0	V
VI	input voltage		[1]	-1.2	+7.0	V
Vo	output voltage	output HIGH or LOW	[1]	-0.5	+5.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-18	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V		-50	-	mA
Io	output current	output in LOW-state		-	40	mA
Tj	junction temperature		[2]	-	150	°C
T <sub>stg</sub>	storage temperature			-65	+150	°C

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>[2]</sup> The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.

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# 8. Recommended operating conditions

 Table 5.
 Operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		4.5	-	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	V
$V_{IH}$	HIGH-level input voltage		2.0	-	-	V
$V_{IL}$	LOW-level input voltage		-	-	0.8	V
I <sub>OH</sub>	HIGH-level output current		-15	-	-	mA
I <sub>OL</sub>	LOW-level output current		-	-	20	mA
Δt/ΔV	input transition rise and fall rate		0	-	5	ns/V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C

# 9. Static characteristics

Table 6. Static characteristics

Symbol	Parameter	Conditions			25 °C		-40 °C t	Unit	
				Min	Тур	Max	Min	Max	
V <sub>IK</sub>	input clamping voltage	$V_{CC} = 4.5 \text{ V}; I_{IK} = -18 \text{ mA}$		-1.2	-0.9	-	-1.2	-	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{CC}$ = 4.5 V; $I_{OH}$ = -15 mA; $V_I$ = $V_{IL}$ or $V_{IH}$		2.5	2.9	-	2.5	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{CC}$ = 4.5 V; $I_{OL}$ = 20 mA; $V_{I}$ = $V_{IL}$ or $V_{IH}$		-	0.35	0.5	-	0.5	V
l <sub>l</sub>	input leakage current	$V_{CC} = 5.5 \text{ V}; V_I = \text{GND or } 5.5 \text{ V}$		-	±0.01	±1.0	-	±1.0	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}; \text{ V}_{I} \text{ or } \text{V}_{O} \le 4.5 \text{ V}$		-	±5.0	±100	-	±100	μΑ
I <sub>CEX</sub>	output high leakage current	HIGH-state; $V_O = 5.5 \text{ V}$ ; $V_{CC} = 5.5 \text{ V}$ ; $V_I = \text{GND or } V_{CC}$		-	5.0	50	-	50	μΑ
Io	output current	V <sub>CC</sub> = 5.5 V; V <sub>O</sub> = 2.5 V	<u>[1]</u>	-50	-75	-180	-50	-180	mA
I <sub>CC</sub>	supply current	$V_{CC} = 5.5 \text{ V}; V_I = \text{GND or } V_{CC}$		-	2	50	-	50	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; V <sub>CC</sub> = 5.5 V; one input at 3.4 V; other inputs at V <sub>CC</sub> or GND	[2]	-	0.25	500	-	500	μΑ
C <sub>I</sub>	input capacitance	$V_I = 0 \text{ V or } V_{CC}$		-	3	-	-	-	pF

<sup>[1]</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

<sup>[2]</sup> This is the increase in supply current for each input at 3.4 V.

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# 10. Dynamic characteristics

**Dynamic characteristics** Table 7.

GND = 0 V; for test circuit, see Figure 7.

Symbol	Parameter	Conditions	25 °C	; V <sub>CC</sub> =	5.0 V	-40 °C to V <sub>CC</sub> = 5.0	Unit	
			Min	Тур	Max	Min	Max	
t <sub>PLH</sub>	LOW to HIGH propagation delay	nA, nB, nC, nD to nY; see Figure 6	1.0	2.7	3.9	1.0	4.6	ns
t <sub>PHL</sub>	HIGH to LOW propagation delay	nA, nB, nC, nD to nY; see Figure 6	1.0	2.2	3.4	1.0	3.8	ns
t <sub>sk(o)</sub>	output skew time	[1]	-	0.3	0.5	-	0.5	ns

<sup>[1]</sup> Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

### 11. Waveforms

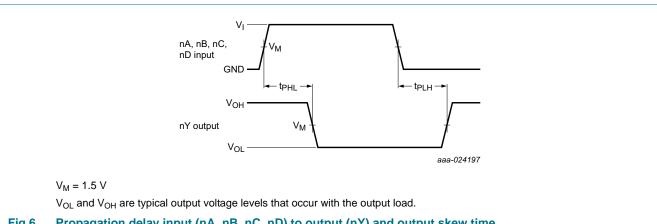
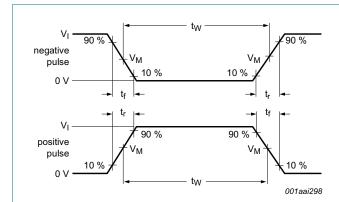
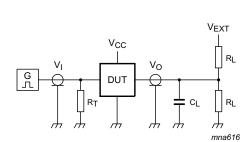


Fig 6. Propagation delay input (nA, nB, nC, nD) to output (nY) and output skew time

### **Dual 4-input NAND gate**





b. Test circuit

a. Input pulse definition

Test data is given in Table 8.

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

Table 8. Test data

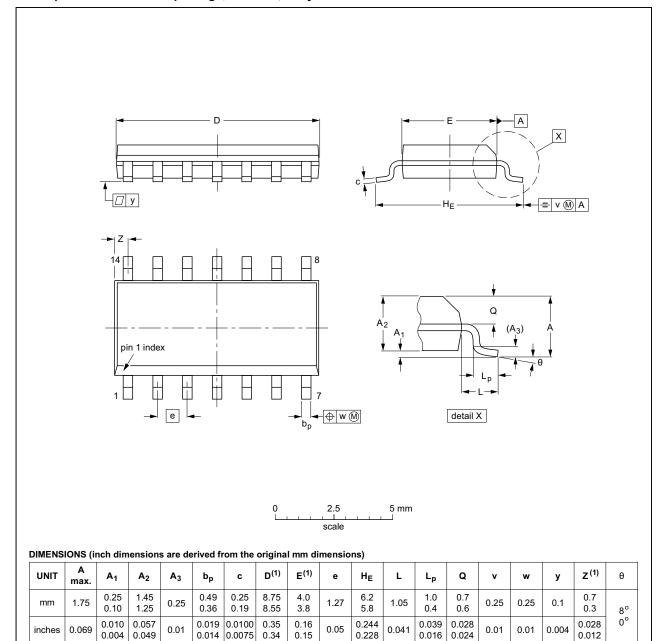
Input			Load	V <sub>EXT</sub>		
VI	fi	t <sub>W</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PHL</sub> , t <sub>PLH</sub>
3.0 V	1 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	open

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## 12. Package outline

### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012			<del>99-12-27</del> 03-02-19

Fig 8. Package outline SOT108-1 (SO14)

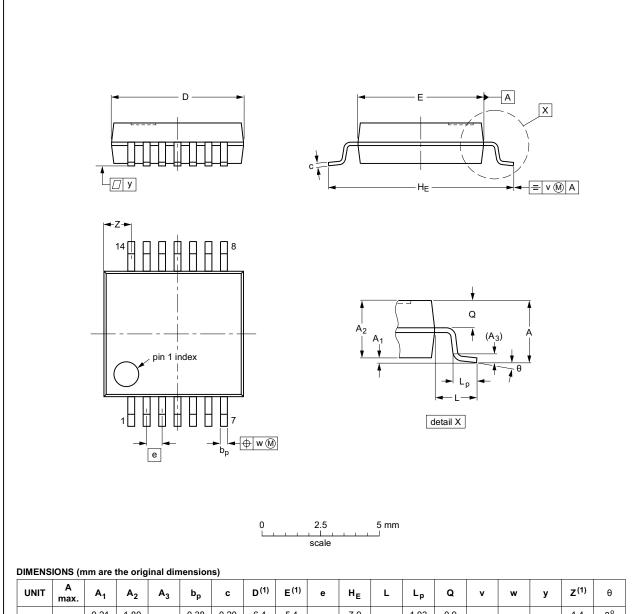
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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	b <sub>p</sub>	C	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	٧	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT337-1		MO-150			<del>99-12-27</del> 03-02-19

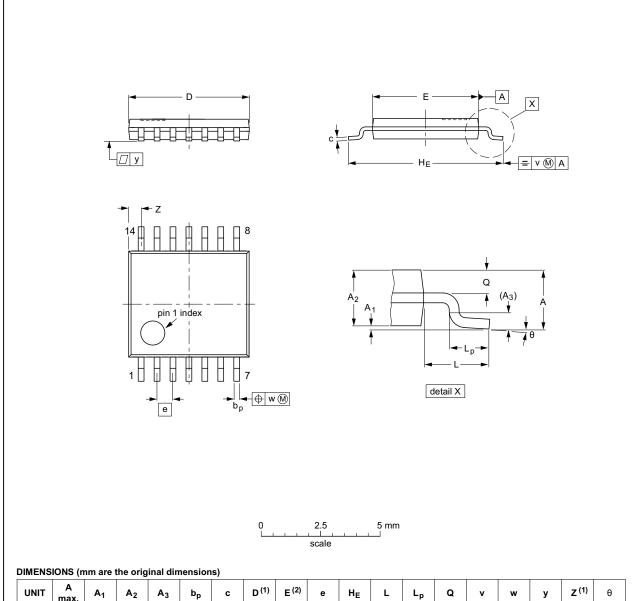
Package outline SOT337-1 (SSOP14) Fig 9.

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	٧	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

				EUROPEAN PROJECTION	ISSUE DATE
IEC	JEDEC	JEITA			
	MO-153				<del>-99-12-27</del> 03-02-18
	120				

Fig 10. Package outline SOT402-1 (TSSOP14)

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## 13. Abbreviations

### Table 9. Abbreviations

Acronym	Description
BiCMOS	Bipolar Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model

# 14. Revision history

### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74ABT20 v.3	20160812	Product data sheet	-	74ABT20 v.2	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>				
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
74ABT20 v.2	19950918	Product specification	-	-	

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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